

bq33100 Super Capacitor Pack Manager EVM

NOTE: BEFORE YOU START: Download the latest revision of the device firmware and the evaluation software from the TI bq33100 product page at <u>www.ti.com</u>. Go to the *Tools and Software* section. For step-by-step instructions on reprogramming the device firmware, refer to the application report <u>SLUA336B</u>.

This evaluation module (EVM) is a complete evaluation system for the bq33100 super capacitor manager. The EVM includes one bq33100 circuit module. An EV2300 PC interface board for gas gauge interface and a PC USB cable are required for communication with a PC and can be ordered online. Windows[™]-based PC software is available online as well. The circuit module includes one bq33100 integrated circuit (IC), charging circuitry, and all other onboard components necessary to monitor and predict state of health, perform charging, perform cell balancing, monitor critical parameters, and protect the super capacitors from overvoltage, short-circuit, and overtemperature in 2-, 3-, 4-, or 5-series super capacitor stacks. The circuit module connects directly across the super capacitor stack. With the EV2300 interface board and software, the user can read the bq33100 data registers, program the chipset for different stack configurations, log cycling data for further evaluation, and evaluate the overall functionality of the bq33100 under different conditions.

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1 Features

- Complete evaluation system for the bq33100 SBS 1.1-compliant super capacitor management IC
- Populated circuit module for quick setup
- PC software and interface board for easy evaluation
- · Software that allows data logging for system analysis

1.1 Kit Contents

- bq33100 circuit module
- Set of support documentation

1.2 Ordering Information

Table 1. Ordering Information

EVM PART NUMBER	CHEMISTRY	CONFIGURATION	CAPACITY
bq33100EVM-001	Super Capacitor	2, 3, 4, or 5 cell	Any

2 bq33100-Based Circuit Module

The bq33100-based circuit module is a complete and compact example solution of a bq33100 circuit for super capacitor management and protection. The circuit module incorporates a bq33100 battery monitor IC, charging circuitry and all other components necessary to accurately predict the capacity of 2-, 3-, 4-, or 5-series cells.

2.1 Circuit Module Connections

Contacts on the circuit module provide the following connections:

- Direct connection to the cells: 1N, 1P, 2P, 3P, 4P, 5P
- To the serial communications port (SMBC, SMBD)
- The system load across CAPOUT and VSS
- The system power across System PWR and System GND
- To the fault pin (FAULT)

PIN NAME	DESCRIPTION		
1N	-ve connection of first (bottom) cap		
1P	+ve connection of first (bottom) cap		
2P	+ve connection of second cap		
3P	+ve connection of third cap		
4P	+ve connection of fourth cap		
5P	+ve connection of fifth (top) cap		
SMBC	Serial communication clock port		
SMBD	Serial communication data port		

bq33100 Circuit Module Schematic

PIN NAME	DESCRIPTION
CAPOUT	System load positive terminal
VSS	System load negative terminal
System PWR	System power positive terminal
System GND	System power negative terminal
FAULT	Fault indicator pin

3 bq33100 Circuit Module Schematic

This section contains information to consider when changing the cell configuration.

3.1 Schematic

The schematic follows the bill of materials in this user's guide.

3.1.1 Modifications for Changing the Cell Configuration

The bq33100 charger provides the option for changing the 4 voltage levels for various cell configurations. The default configuration assumes a 5-cell configuration. An adjustment to these voltages will need to be made for 2-, 3-, or 4- cell configurations. Adjusting the charging levels requires changing out R5, R6, and R7. See Table 2 for common 2-, 3-, 4-, and 5- cell configurations.

	2-Cell	3-Cell	4-Cell	5-Cell
R4	30kΩ	30kΩ	30kΩ	30kΩ
R5	137kΩ	93.1kΩ	68.1kΩ	57.6kΩ
R6	300kΩ	187kΩ	150kΩ	125kΩ
R7	44.2kΩ	19.6kΩ	12.7kΩ	9.31kΩ

 Table 2. Common Charging Voltage Configurations for 2-, 3-, 4-, and 5- Cell Monitors

Another modification to consider is to R26. This resistor is used to dissipate extra power in the learn load circuit. For 4- and 5-cell configurations the resistor should be 7.5 Ω , 2 W. For 2- and 3-cell configurations, R26 should be removed.

4 Circuit Module Physical Layouts and Bill of Materials

This section contains the board layout, bill of materials, and assembly drawings for the bq33100 circuit module.

4.1 Board Layout

This section shows the dimensions, PCB layers (Figure 1 through Figure 7), and assembly drawing for the bq33100 module.



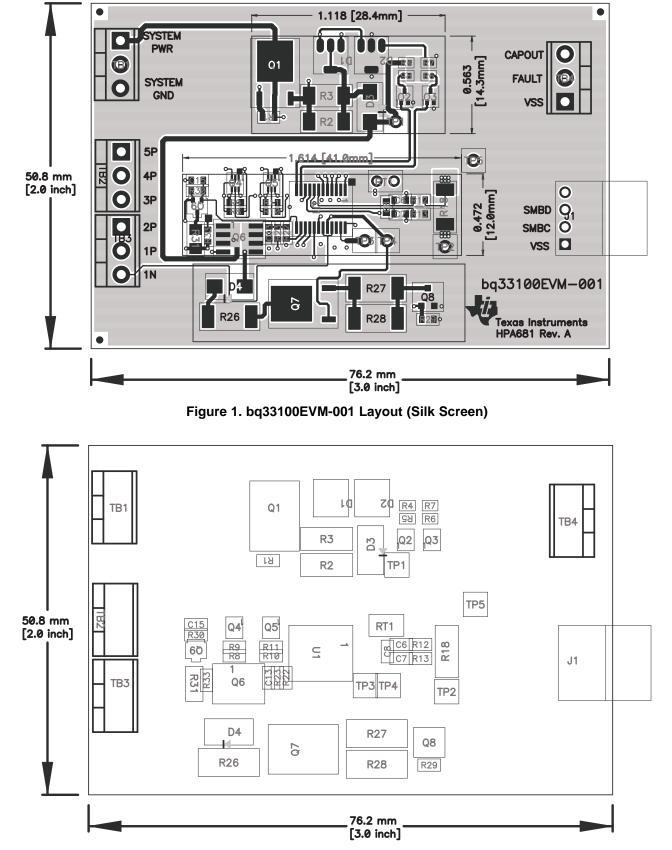
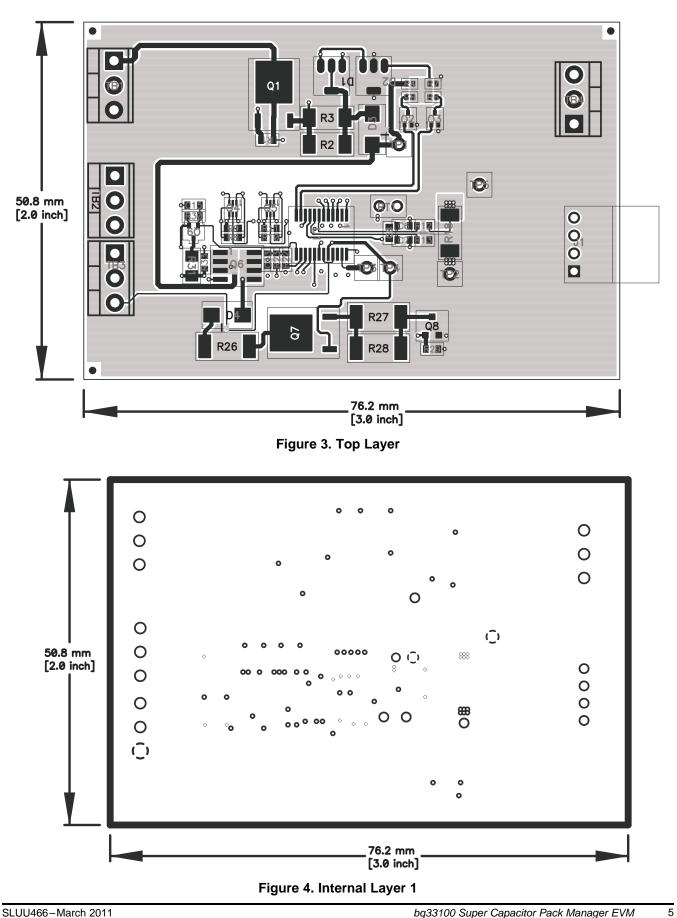


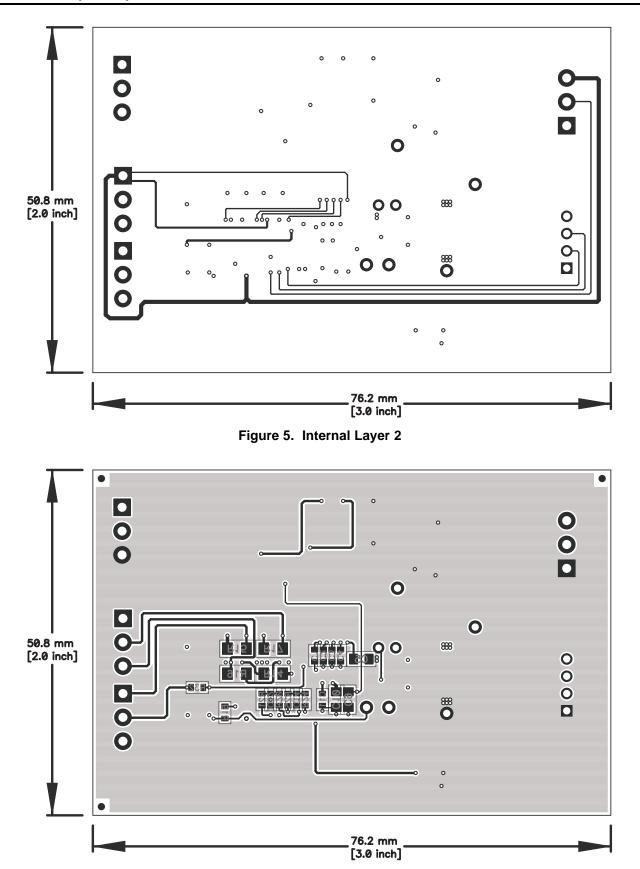
Figure 2. Top Assembly







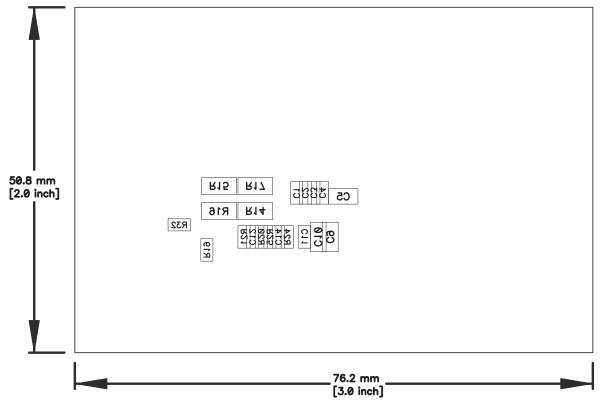
















4.2 Bill of Materials and Schematic

COUNT	RefDes	Value	Description	SIZE	Part Number	Mfr
9	C1, C2, C3, C4, C6, C7, C8, C11, C15	0.1 µF	Capacitor, Ceramic, 50V, X7R, 20%	0603	STD	Any
3	C12, C13, C14	100 pF	Capacitor, Ceramic, 50V, X7R, 10%	0603	STD	Any
3	C5, C9, C10	1.0 µF	Capacitor, Ceramic, 25V, X7R, 20%	0805	STD	Any
2	D1, D2	TL431CPK	IC, Adjustable precision shunt regulator	SOT-89	TL431CPK	TI
2	D3, D4	S1A-13-F	Diode, Glass Passivated Rect. 1A, 50V	SMA	S1A-13-F	Diodes
1	J1	22-05-3041	Header, Friction Lock Ass'y, 4-pin Right Angle	0.400 x 0.500	22-05-3041	Molex
2	Q1, Q7	2SD1758TLR	Transistor, NPN Medium Power, 32V, 2A	SC-63	2SD1758TLR	Rohm
2	Q2, Q3	2SK3019	MOSFET, Nch, 30V, 100mA, 8 Ohm	SC-75A	2SK3019	Rohm
2	Q4, Q5	Si1023X	MOSFET, Pch, -20V, 350mA, 1.2 Ohm	SC-89	Si1023X-T1-E3	Vishay
1	Q6	Si4435DDY	MOSFET, Pch, 30V, 8.0A, 20 milliohm	SOT23	Si4435DDY-T1-E3	Vishay
1	Q8	ZXMN3A14FTA	MOSFET, Nch, 30V, 3.2A, 65 milliOhm	SOT23	ZXMN3A14FTA	Diodes/Zetex
1	Q9	BSS223PW	MOSFET, Pch, -20V, -0.39A, 1.2 Ohm	SOT323	BSS223PW	Infineon
5	R1, R8, R9, R10, R11	1K	Resistor, Chip, 1/16W, 5%	0603	STD	Any
5	R12, R13, R21, R23, R25	100	Resistor, Chip, 1/16W, 5%	0603	STD	Any
5	R14, R15, R16, R17, R31	100	Resistor, Chip, 1/4W, 5%	1206	CRCW1206100RJNEA	Vishay
1	R18	.020 75ppm	Resistor, Chip, 1/2W, 1%, 75ppm	2010	WSL2010R0200FEA	Dale
1	R19	3M	Resistor, Chip, 1/16W, 5%	0603	STD	Any
2	R2, R3	10	Resistor, Chip, 1W, 1%	2010	CRCW201010R0FKEFHP	Vishay/Dale
3	R20, R22, R24	200	Resistor, Chip, 1/16W, 5%	0603	STD	Any
1	R26	7.5	Resistor, Chip, 2W, 1%	2512	RHC2512FT7R50	Stackpole
2	R27, R28	8.2	Resistor, Chip, 1W, 1%	2512	ERJ-1TRQF8R2U	Panasonic - ECG
0	R29	DNP	Resistor, Chip, 1/16W, 5%	0603	STD	Any
1	R30	20K	Resistor, Chip, 1/16W, 5%	0603	STD	Any
1	R32	20K	Resistor, Chip, 1/16W, 1%	0603	STD	Any
1	R33	10K	Resistor, Chip, 1/16W, 1%	0603	STD	Any
1	R4	30.0K	Resistor, Chip, 1/16W, 1%	0402	STD	Any
1	R5	57.6K	Resistor, Chip, 1/16W, 1%	0402	STD	Any
1	R6	124K	Resistor, Chip, 1/16W, 1%	0402	STD	Any
1	R7	9.31K	Resistor, Chip, 1/16W, 1%	0402	STD	Any

Table 3. Bill of Materials

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Table 3. Bill of Materials (continued)

COUNT	RefDes	Value	Description	SIZE	Part Number	Mfr
1	RT1	10K	Thermistor, 10K Ohm	0.095 x 0.150 inches	103AT-2	Semitec
4	TB1, TB2, TB3, TB4	ED555/3DS	Terminal Block, 3-pin, 6A, 3.5mm	0.41 x 0.25 inch	ED555/3DS	OST
1	TP1	CHG+	Test Point, White, Thru Hole Color Keyed	0.100 x 0.100 inch	5002	Keystone
1	TP2	CHG-	Test Point, White, Thru Hole Color Keyed	0.100 x 0.100 inch	5002	Keystone
1	TP3	CHGFET	Test Point, White, Thru Hole Color Keyed	0.100 x 0.100 inch	5002	Keystone
1	TP4	2.7V	Test Point, White, Thru Hole Color Keyed	0.100 x 0.100 inch	5002	Keystone
1	TP5	GND	Test Point, White, Thru Hole Color Keyed	0.100 x 0.100 inch	5002	Keystone
1	U1	BQ33100PW	IC, SUPERCAP PACKMANAGER and PROTECTION	TSSOP-24	BQ33100PW	TI
1	-		PCB	2 x 3 inches	HPA681	Any
	H		Connector		- H	
2		J1 mate	Connector, Female, 0.100 Centers		Molex	22-01-3047
8		N/A	Terminals, Crimp, Tin		Molex	08-50-0114
1		N/A	Wire, Insulated 24 Awg, Red, 18 Inches (+/- 3 inches)(USB_5V)	Wire, Insulated 24 Awg, Red, 18 Inches (+/- 3		1854-3
1		N/A	Wire, Insulated 24 Awg, White, 18 Inches (+/- 3 inches)(SCL)	}	Alpha	1854-1
1		N/A	Wire, Insulated 24 Awg, Black, 18 Inches (+/- 3 inches)(GND)		Alpha	1854-2
1		N/A	Wire, Insulated 24 Awg, Brown, 18 Inches (+/- 3 inches) (SDA)	3	Alpha	1854-7
1		N/A	Heatshrink 1"		Any	Any



COUNT	RefDes	Value	Description	SIZE	Part Number	Mfr		
Notes:	1. These ass	emblies are ESD sens	sitive, ESD precautions shall be obse	erved.				
	2. These ass	emblies must be clear	and free from flux and all contamin	ants. Use of no clean flux is not accept	table.			
	3. These ass	emblies must comply	with workmanship standards IPC-A-	610 Class 2.				
	4. Ref design	nators marked with an	asterisk ('**') cannot be substituted.	All other components can be substitute	ed with equivalent MFG's compor	nents.		
			e assembly for each assembly produ ve a J1 mate on each end.	uced, from J1 mate, 4 - 24 Awg wires a	nd Crimp terminals. Wire colors	for Pin numbers are listed		
	Red - Pin # 4 (Signal USB_5V)							
		Bro	wn - Pin # 3 (Signal SDA)					
		Wh	ite - Pin # 2 (Signal SCL)					
			Black - Pin # 1 (GND)					
	6. RT1 shoul	d be assembled horize	ontally laying flat against the board E	Edge.				

Table 3. Bill of Materials (continued)





TB2 5P

4P 3P B3 2P 1P 1N

2

R8 ₹1K

 \mathbb{A} R8-R11: Required to be 1k.

- ◬ IC ground should be connected to the 1N cell tab.
- A R14 - R17 and R31: If smaller resistors are used, user should make sure the power
- A R29 should not be installed.
- For 2-cell and 3-cell configurations, R26 should be removed and replaced with a ∕ 0-Ohm resistor or shorted.

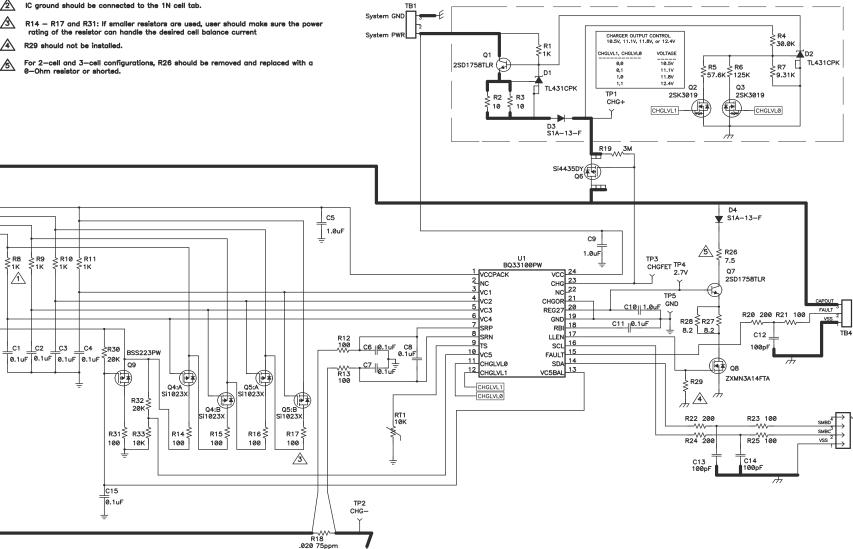


Figure 8. Schematic

4.3 bq33100 Circuit Module Performance Specification Summary

Specification	Minimum	Typical	Maximum	Units
Input Voltage System PWR to System GND	6	12	15	V
Discharge current	0	2	7	А

Table 4. Performance Specification Summary

5 EVM Hardware and Software Setup

This section describes how to install the bq33100EVM-001 PC software, and how to connect the different components of the EVM.

5.1 System Requirements

The bq33100EVSW software requires Windows[™] 2000 or Windows XP[™]. Drivers for Windows 98SE are provided, but Microsoft[™] no longer supports Windows 98 and there may be issues in Windows 98 with USB driver support. The EV2300 USB drivers have been tested for Windows 98SE, but no assurance is made for problem-free operation with specific system configurations.

5.2 Software Installation

Get the latest software version in the bq33100 tool folder on <u>www.ti.com</u>, and follow these steps to install the bq33100 EVSW software:

- 1. Save the archive to a temporary directory. Open the archive containing the installation package, and copy its contents to a temporary directory. The executable filename can consist of several component names and versions. Double-click on the executable filename, and follow the installer instructions to complete the bq33100 EVM installation.
- 2. If the EV2300 was not previously installed, after bq33100 EVM installation, a TI USB DRIVER INSTALLER pops up. Click "Yes" for the agreement message and follow its instructions.
- 3. Plug the EV2300 into a USB port.

6 Troubleshooting Unexpected Dialog Boxes

Ensure that the files were extracted from the zip file using the Preserve Folder names option.

Ensure that all the files were extracted from the zip file.

The user that is downloading the files must be logged in as the administrator.

The driver is not signed, so the administrator must allow installation of unsigned drivers in the operating system policy.

7 Hardware Connection

The bq33100EVM-001 comprises three hardware components: the bq33100 circuit module, the EV2300 PC interface board, and the PC.

7.1 Connecting bq33100 Circuit Module to Super Capacitor Stack

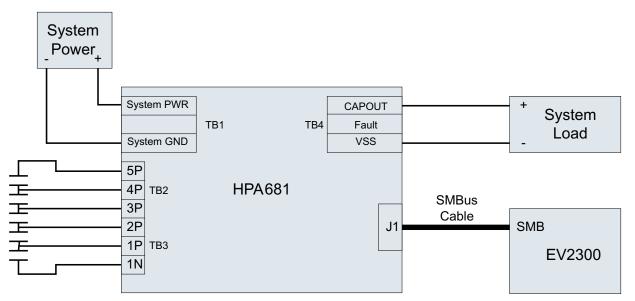
Figure 9 shows how to connect the bq33100 circuit module to the super capacitors, system load, and system power.

The super capacitors should be connected in the following order:

- 1. 5-Cell Pack: 1N, 1P, 2P, 3P, 4P, and 5P (see Section 2.1 for definitions).
- 2. 4-Cell Pack: 1N and 1P are connected together, 2P, 3P, 4P, and 5P.
- 3. 3-Cell Pack: 1N and 1P are connected together, 2P, 3P, and then connect 4P and 5P together.
- 4. 2-Cell Pack: 1N and 1P are connected together, 2P, and then connect 3P, 4P and 5P together.



Connect the system load between the CAPOUT and VSS terminals. Connect the system power between the System PWR and System GND terminals.





7.2 PC Interface Connection

The following steps configure the hardware for interface to the PC:

1. Connect the bq33100 circuit module to the EV2300 using wire leads as shown in Table 5.

Table 5. Circuit Module to EV2300 Connections

bq33100 Circuit Module	EV2300
SMBD	SMBD
SMBC	SMBC
VSS	GND

2. Connect the PC USB cable to the EV2300 and the PC USB port.

The bq33100EVM-001 is now set up for operation.

8 Operation

This section details the operation of the bq33100 EVSW software.

8.1 Starting the Program

Run bq Evaluation Software from the Start | Programs | Texas Instruments | bq33100 EVSW menu sequence. The SBS Data screen (Figure 10) appears. Data begins to appear once the <Refresh> (single time scan) button is clicked, or when the <Keep Scanning> check box is checked. To disable the scan feature, deselect <Keep Scanning>.

The continuous scanning period can be set via the | Options | and | Set Scan Interval | menu selections. The range for this interval is 0 ms to 65535 ms. Only items that are selected for scanning are scanned within this period.

The bq Evaluation Software provides a logging function which logs the values that were last scanned by EVSW. To enable this function, select the *Start Logging* button, this causes the *Keep Scanning* button to be selected. When logging is *Stopped*, the keep scanning button is still selected and has to be manually unchecked.



Operation

www.ti.com

The logging intervals are specified under the | Options | menu with the maximum value of 65535 ms. The *Log* interval cannot be smaller than the *Scan* interval because this results in the same value being logged at least twice.

- N	AutoCycle Vie	_												
	🜵 Texas I	NSTRUME	NTS			Ret	E A	L W D.R	10 \$	1 B N	A L	P	H O	CESS
		tart Sto Iging Logg	Aler a	Keep anning			e <u>2</u> wo							
	Name		Value	Unit	Log	Scan	- 1	Name)	Value	Unit	Log	Scan	1
	Manufacturer	Access	0000	hex	Г			Charging Voltag	IC.	9000	mV	Г		
1	Temperature		25.55	degC	F	V		Capacitor Volta	ge 5	2013	mV	Г	1	
85	Voltage		10033	mV		V		Capacitor Volta	ge 4	2018	mV	Г	1	
	Current		2	mA				Capacitor Volta	ge 3	2008	mV	Г	V	
_	ESR		400	mohm	Г			Capacitor Volta	ge 2	1962	mV	Г	1	
	Relative State	e of Charge	100	%				Capacitor Volta	ge 1	2003	mV	Г	V	
ta	Health	All and a state	100	%	F	V		Operation Statu	IS	1014	hex	Г	1	
ash	Capacitance		2.00	F	Г			Safety Status		0000	hex	Г		
asn	Charging Curr	rent	500	mA	Г			Safety Alert		0000	hex	V		
	LDTO	LCTO	LPASS		CL		14	CFET			_			
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	L urr		Are_u	-	VU DP	-	ULL		366	1 300	_			
-														

Figure 10. SBS Data Screen

This screen (Figure 10) shows the SBS data set along with additional ManufacturersAccess() command information such as individual cell measurements. Additional Flag and Static data can be viewed by selecting the appropriate tab at the bottom of the SBS screen.

Data such as SBS.ManufacturerName() is static and does not change. This data is viewed separately using the *Static Data* tab available at the bottom of the screen.

Dragging the splitter bar (line that separates the Flags/Static data from SBS values) changes the height of the Flags/Static Data display. Selecting | View |, then | Auto Arrange | returns the splitter bar to its original location.

The bq33100 data flash comes configured per the default settings detailed in the bq33100 data sheet. Ensure that the settings are correctly changed to match the capacitor stack and application for the bq33100 solution being evaluated.

IMPORTANT: The correct setting of these options is essential to get the best performance.

The settings can be configured using the Data Flash screen (Figure 11).

Bead Al Wite All. Breserve "Right click on constant name for more information Calibration Safety Charge Control System Data Configuration Monitoring Name Value Unit Orgen Orgen Orgen Orgen OV Threshold 100 mV Orgen Orgen Orgen Orgen OV Time 2 Sec Orgen F4 hex OV Time 2 Sec Orgen F4 hex OC Dag Recovery 5 mV Sc Chg Cfg F4 hex Or Chy 1000 mV Sc Chg Cfg F7 hex Or Chg 1000 mA Created - - Or Chg Recovery 1 mA Oc Chg Time 5 Sec Or Chg Re	TEXAS INSTRUME	NTS	RE	AL WORLD S	TENAL	P R D C E I
Safety Charge Control System Data Configuration Monitoring Name Value Unit Name Value Unit Voltage - - OC Dsg OF hex OV Threshold 100 mV OC Dsg OF hex OV Recovery 0 mV OC Dsg OF hex OV Time 2 Sec OC Dsg Recovery 5 mA CIM Fail Voltage 550 mV SC Chg Cfg F4 hex CIM Recovery 500 mV SC Recovery 1 mA Min CIM Check Voltage 1000 mV SC Recovery 1 mA Min CIM Check Voltage 1000 mV Temperature - - OC Chg 1000 mA OT Chg 68.0 degC OC Chg Recovery 900 mA OT Chg Recovery 63.0 degC OC Chg Recovery 900 mA AFE Verification - - OC Chg Recovery 900 mA AFE Verification <td< th=""><th>Bead All Write All</th><th>Write A</th><th>Al<mark>l, P</mark>reserve</th><th>*Right click on constant nam</th><th>e for more infor</th><th>nation</th></td<>	Bead All Write All	Write A	Al <mark>l, P</mark> reserve	*Right click on constant nam	e for more infor	nation
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CIM Time10SecSC Dsg CfgF7hexCIM Recovery500mVSC Recovery1mAMin CIM Check Woltage1000mVSC Recovery1mACurrentOT Chg68.0degCOC Chg1000mAOT Chg Time2SecOC Chg Time5SecOT Chg Recovery63.0degCOC Chg Recovery900mAAFE VerificationCLBAD Current15mAAFE Fail Limit100numCLBAD Time60SecAFE Init Retry Limit6num	CIM Fail Voltage	550	mV	SC Chg Cfg	F4	hex
CIM Recovery 500 mv Sc Recovery 1 mA Min CLM Check Voltage 1000 mV Temperature - - OC Chg 1000 mA OT Chg 68.0 degC OC Chg 1000 mA OT Chg 68.0 degC OC Chg 1000 mA OT Chg Time 2 Sec OC Chg Time 5 Sec OT Chg Recovery 63.0 degC OC Chg Recovery 900 mA AFE Verification - - CLBAD Current 15 mA AFE Fail Limit 100 num CLBAD Time 60 Sec AFE Init Retry Limit 6 num	CTU Time	10	Sec	SC Dsg Cfg	F7	hex
CurrentOT Chg68.0degCOC Chg1000mAOT Chg Time2SecOC Chg Time5SecOT Chg Recovery63.0degCOC Chg Recovery900mAAFE VerificationCLBAD Current15mAAFE Fail Limit100numCLBAD Time60SecAFE Init Retry Limit6num	CIM Recovery	500	mV	SC Recovery	1	mA
OC Chg 1000 mA OT Chg Time 2 Sec OC Chg Time 5 Sec OT Chg Recovery 63.0 degC OC Chg Recovery 900 mA AFE Verification - - CLBAD Current 15 mA AFE Fail Limit 100 num CLBAD Time 60 Sec AFE Init Retry Limit 6 num	Min CIM Check Voltage	1000	mV	Temperature	21	1.1
OC Chg Time 5 Sec OT Chg Recovery 63.0 degC OC Chg Recovery 900 mA AFE Verification - - CLBAD Current 15 mA AFE Fail Limit 100 num CLBAD Time 60 Sec AFE Init Retry Limit 6 num	Current	-		OT Chg	68.0	degC
OC Chg Recovery 900 mA AFE Verification - CLBAD Current 15 mA AFE Fail Limit 100 num CLBAD Time 60 Sec AFE Init Retry Limit 6 num	OC Chg	1000	mA	OT Chg Time	2	Sec
CLBAD Current 15 mA AFE Fail Limit 100 num CLBAD Time 60 Sec AFE Init Retry Limit 6 num	OC Chg Time	5	Sec	OT Chg Recovery	63.0	degC
CLBAD Time 60 Sec AFE Init Retry Limit 6 num	OC Chg Recovery	900	mA	AFE Verification	4	1.1
	CLBAD Current	15	mA	AFE Fail Limit	100	num
CLBAD Recovery 10 mA AFE Init Limit 20 ont	CLBAD Time	60	Sec	AFE Init Retry Limit	6	num
	CLBAD Recovery	10	mA	AFE Init Limit	20	cnt

Figure 11. Data Flash Screen, Safety Class

To read all the data from the bq33100 data flash, click on menu option | Data Flash | Read All |.

To write to a data flash location, click on the desired location, enter the data and press <Enter>, which writes the entire tab of flash data, or select menu option | Data Flash | Write All |. The data flash must be read before any writes are performed to avoid any incorrect data being written to the device.

The | File | Special Export | menu options allows the data flash to be exported, but it configures the exported data flash to a learned state ready for mass production use.

The data flash configuration can be saved to a file by selecting | File | Export | and entering a file name. A data flash file also can be retrieved in this way, imported, and written to the bq33100 using the | Write All | button.

Operation



The configuration information of the bq33100 and module calibration data also is held in the bq33100 data flash.

The bq33100 allows for an automatic data flash export function, similar to the SBS Data logging function. This feature, when selected via | Options | Auto Export |, exports Data Flash to a sequential series of files named as *FilenameNNNN.gg* where N = a decimal number from 0 to 9.

The AutoExport interval is set under the | Options menu | with a minimum value of 15 s. The AutoExport filename also is set under the | Options menu |.

When a check mark is next to | AutoExport |, the AutoExport is in progress. The same menu selection is used to turn on / off AutoExport.

If the data flash screen is blank, then the bq33100 that is being used may not be supported by the bqEVSW version that is being used. An upgrade may be required.

9 Calibration Screen

9.1 How to Calibrate

Before the bq33100 is calibrated:

- Connect 12V to System PWR and System GND inputs
- Connect a load to CAPOUT and VSS that draws approximately 0.5 A and measures discharge current to use the FET, or
- Connect a current source to 1N and VSS to calibrate without using the FET.
- Measure individual cell stack voltage from 1N, to Cap1(1P), Cap1 + 2(2P), Cap1 + 2 + 3(3P), Cap1 + 2 + 3 + 4(4P), Cap1 + 2 + 3 + 4 + 5(5P).
- Measure the voltage from the System PWR to System GND inputs
- Measure the temperature of the pack.

These steps may not be required, depending on the type of calibration being performed.

Note that voltage calibration with capacitors attached requires special consideration. Capacitors must be in a resting state.

9.2 To Calibrate the bq33100

Select the types of calibration to be performed (see Figure 12).

Enter the measured values for the types selected.

If Capacitor Stack Voltage Calibration is selected, then enter the capacitor voltages.

If the load is connected between CAPOUT and VSS-, then select the On (External Load) radio button.

Press the Calibrate Part button.

9.3 System Voltage Calibration

This calibrates the voltage at the VCC pin.

Make sure *Capacitor Stack Voltage Calibration* has been performed for the pack. If *Capacitor Stack Voltage Calibration* is not performed, then *System Voltage Calibration* calibrates incorrectly.

Remove load/external voltage applied between CAPOUT and VSS.

Check the System Voltage Calibration box, and enter the measured System PWR voltage

Press the Calibrate device as indicated below button to calibrate.

<u>File Window</u>	Help		re - bq33100 v0.			- 3			
dib	🛷 Texas Inst	RUMENTS	REAL	WORI	D SIGNAL P	HOCESS			
<u>×</u>	Please ensure that so <u>C</u> alibrate device as indicated below	canning/communication is of	T	he number o arameter in d	Version: 0.0.2 f configured capacitors is read fror ata flash. Actual voltage entry is d used. Actual stack voltage will us or voltage.	isabled for			
SBS Data Flash Pro	Capacitor Stack Voltage Calibration	6317 mV Capac 8441 mV Capacito 10583 mV Capacito	Enter actu voltage Capacitor 1 2 200 pacitor 1 + 2 4200 itor 1 + 2 + 3 6300 r 1 through 4 8400 r 1 through 5 10500 ack Voltage	mV mV Ens mV If us	ries Capacitor Count Finan ure voltage reference is stable. Ca nected should be charged and in- ing resistive dividers simulating ca ut impendance for each capacitor ut impendance for each capacitor uid be less than 300 ohms for best	a state of rest. pacitors, the r connection			
Calibrate	System Voltage Calibration	Measured system voltage 14987 mV	Actual system	n voltage mV	Apply a known voltage to system Enter this voltage into actual syst and check to include in calibratic	em voltage			
	Calibration	Measured temperature 24.9 deg C	Enter actual te	er actual temperature					
100%			Current Ca	Current Calibration					
0% Fuel Gauge	Current	Measured Enter current currer 0 mA -500	nt r	arge FET (On (External Off (Bypasse	Load) Apply a 0.5 Ampere load current. Discha				

Figure 12. Calibration Screen

10 Pro (Advanced) Screen

10.1 SMB Communication

The set of read/write operations over SMBus are not specific to any gas gauge. These are provided as general-purpose communication tools (Figure 13).

10.2 Hexadecimal/Decimal Converter

These two boxes convert between hexadecimal and decimal as soon as values are typed into the boxes. Invalid values may cause erroneous results.

When scaling converted hexadecimal values to a higher number of bytes, follow these rules:

- When unsigned is selected, the left pad contains zeroes.
- When signed is selected, the left pad contains zeroes for a positive number, or the left pad contains *F* for negative numbers.



10.3 Programming

This screen allows device reprogramming from unencrypted and encrypted files.

	uments bq Gas Gauge Evaluation Software - bq33100 v0.08 - [Pro (Advanced) Screen]
Eile Options	Flash_Memory Window Help
4000	TEXAS INSTRUMENTS REAL WORLD SIGNAL PROCESSING
	This screen is only for advanced users. Some commands may cause permanent damage to the hardware. Please use caution. All Values are in Hexadecimal without the 0x prefix. Target Address 17 Send SMB Command
	SMB Command 08 Send
	Read SMB Word
SBS	SMB Command ODBead Result (hex) None.
1947 - P.	Write SMB Word
Data Flash	SMB Command 00 Word (hex) 0000 Wite Vite
Fidsh	Read SMB Block
_	SMB Command 68 Read Result (hex) None.
Pro	Result (ASCII)
	Write SMB Block
Calibrate	SMB Command 00 Block Data wite
1	Hexadecimal to Decimal converter and vice versa
	Hexadecimal value 00 = Signed Decimal value 00
100%	Srec programming
0% Fuel Gauge -	
Communication DK	SBS Task Progress: 100% Task Completed. 11:59:01 AM

Figure 13. Pro (Advanced) Screen



11 Stack Assembly and the bq33100

This section describes a recommended assembly sequence for a bq33100-based super capacitor stack. This procedure results in the most time-efficient setup of the super capacitor stack. Following are the steps for connecting a 5-series capacitor stack to the bq33100EVM board.

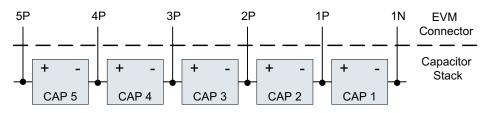


Figure 14. Connection Sequence

- Connect the most negative terminal (– terminal of cap 1) of the serially-connected, 5-capacitor stack to the 1N PIN of the TB2–TB3 connector as shown in Figure 14. (See also Figure 9 for TB2–TB3 location).
- 2. Connect the positive terminal of cell 1 to 1P.
- 3. Connect the positive terminal of cell 2 to 2P.
- 4. Connect the positive terminal of cell 3 to 3P.
- 5. Connect the positive terminal of cell 4 to 4P.
- 6. Connect the positive terminal of the capacitor stack (+) to 5P.
- 7. Connect external power (from 6 V to 15 V) to the System PWR and System GND terminals to wake up the EVM from shutdown mode.
- 8. Connect the SMBus connector (J1) to the EV2300 adapter and start the EV software.
- 9. Navigate to the *Flash Screen*. Change the flash constants that correspond to the specific parameters of your application (see the data sheet). For the first evaluation, the default values may be used.
- Navigate to the *Calibration screen*. Select the check-box for software voltage calibration near *Measured voltage* field. Measure between 1P and 1N for capacitor 1, 2P and 1N for capacitors 1 + 2, 3P and 1N for capacitors 1 + 2 + 3, 4P and 1N for capacitors 1 + 2 + 3 + 4, 5P and 1N for capacitors 1 + 2 + 3 + 4 + 5 and enter the values into the *Enter actual voltage* field. Click the *calibrate part* button.
- 11. Now the pack is ready and charge/discharge tests can be conducted.

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Exceeding the specified input range may cause unexpected operation and/or irreversible damage to the EVM. If there are questions concerning the input range, please contact a TI field representative prior to connecting the input power.

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During normal operation, some circuit components may have case temperatures greater than 60°C. The EVM is designed to operate properly with certain components above 60°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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